

L Number	Hits	Search Text	DB	Time stamp
1	2	438/\$.ccls. and waveguide and interfacial near bond	USPAT; US-PGPUB	2003/07/29 12:46
2	19	438/\$.ccls. and interfacial near bond	USPAT; US-PGPUB	2003/07/29 12:50
3	0	(interfacial near bond) with lamina	USPAT; US-PGPUB	2003/07/29 12:51
4	0	(interfacial near bond) same lamina	USPAT; US-PGPUB	2003/07/29 12:51
5	0	interfacial near bond same lamina	USPAT; US-PGPUB	2003/07/29 12:52
6	636	interfacial near bond	USPAT; US-PGPUB	2003/07/29 12:56
7	0	interfacial near bond with waveguide	USPAT; US-PGPUB	2003/07/29 12:52
8	0	interfacial near bond same waveguide	USPAT; US-PGPUB	2003/07/29 12:52
9	10	interfacial near bond and waveguide	USPAT; US-PGPUB	2003/07/29 12:55
10	0	interfacial near bond and waveguide	IBM_TDB	2003/07/29 12:55
11	1	interfacial near bond	IBM_TDB	2003/07/29 12:55
12	104	interfacial near bond and laser	USPAT; US-PGPUB	2003/07/29 12:57
-	268	(438/31).CCLS.	USPAT; US-PGPUB	2003/07/29 12:16
-	2	438/\$.ccls. and waveguide and interfacial near bond and modified	USPAT; US-PGPUB	2003/07/29 12:46
-	8	438/\$.ccls. and waveguide and modified and unmodified	USPAT; US-PGPUB	2003/07/29 12:32
-	0	438/\$.ccls. and waveguide with unmodified	USPAT; US-PGPUB	2003/07/29 12:32